

| | | | |
|--------------------------|---------------------------|-------------------------------------|---------------------|
| PCN Number: | 20190703003 | PCN Date: | Aug. 9, 2019 |
| Title: | Datasheet for LMG1210 | | |
| Customer Contact: | PCN Manager | Dept: | Quality Services |
| Change Type: | | | |
| <input type="checkbox"/> | Assembly Site | <input type="checkbox"/> | Design |
| <input type="checkbox"/> | Assembly Process | <input checked="" type="checkbox"/> | Data Sheet |
| <input type="checkbox"/> | Assembly Materials | <input type="checkbox"/> | Part number change |
| <input type="checkbox"/> | Mechanical Specification | <input type="checkbox"/> | Test Site |
| <input type="checkbox"/> | Packing/Shipping/Labeling | <input type="checkbox"/> | Test Process |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Bump Site |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Bump Material |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Bump Process |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Fab Site |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Fab Materials |
| <input type="checkbox"/> | | <input type="checkbox"/> | Wafer Fab Process |

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



LMG1210

SNOSD12D –NOVEMBER 2018–REVISED JANUARY 2019

| Changes from Revision C (December 2018) to Revision D | Page |
|--|------|
| • Changed Maximum High-side dynamic current from 0.61mA/MHz to 0.7mA/MHz | 5 |

The datasheet number will be changing.

| Device Family | Change From: | Change To: |
|---------------|--------------|------------|
| LMG1210 | SNOSD12C | SNOSD12D |

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LMG1210>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

| | | | |
|-------------|-------------|--|--|
| LMG1210RVRR | LMG1210RVRT | | |
|-------------|-------------|--|--|

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

| Location | E-Mail |
|--------------|--|
| USA | PCNAmericasContact@list.ti.com |
| Europe | PCNEuropeContact@list.ti.com |
| Asia Pacific | PCNAsiaContact@list.ti.com |
| WW PCN Team | PCN_ww_admin_team@list.ti.com |

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